

1-535541-3 ✓ ACTIVE

AMPMODU | Modu Connector System

TE Internal #: 1-535541-3

PCB Mount Receptacle, Vertical, Board-to-Board, 15 Position, 2.54 mm [.1 in] Centerline, Gold (Au), Through Hole - Solder, Modu Connector System

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Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Type: **PCB Mount Receptacle**

PCB Mount Orientation: **Vertical**

Connector System: **Board-to-Board**

Number of Positions: **15**

Number of Rows: **1**

Features

Product Type Features

Applied Pressure	Standard
PCB Connector Type	PCB Mount Receptacle
Connector System	Board-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Connector Product Type	Connector Assembly

Configuration Features

Board-to-Board Configuration	Parallel
Stackable	Yes
PCB Mount Orientation	Vertical
Number of Positions	15
Number of Rows	1

Electrical Characteristics

Operating Voltage	333 VAC
Insulation Resistance	5000 MΩ
Dielectric Withstanding Voltage (Max)	750 VAC

Body Features

Connector Profile	Standard
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Primary Product Color	Black
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Contact Features

Contact Mating Area Plating Material Thickness	.762 μm[30 μin]
Mating Square Post Dimension	.64 mm[.025 in]
PCB Contact Termination Area Plating Material Thickness	3.81 – 50 μm
Contact Shape & Form	Square
Contact Layout	Inline
Contact Protection Type	Closed Entry Housing
Contact Base Material	Phosphor Bronze
PCB Contact Termination Area Plating Material	Tin-Lead
Contact Mating Area Plating Material	Gold (Au)
Contact Type	Socket
Contact Current Rating (Max)	3 A

Termination Features

Rectangular Termination Post & Tail Width	.7 mm[.028 in]
Rectangular Termination Post & Tail Thickness	.2 mm[.008 in]
Termination Post & Tail Length	3.18 mm[.125 in]
Termination Method to PCB	Through Hole - Solder

Mechanical Attachment

PCB Mount Retention	Without
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount
Mating Alignment	Without

Housing Features

Mating Entry Location	Top
Housing Material	Polyester - GF
Centerline (Pitch)	2.54 mm[.1 in]

Dimensions

Stack Height	9.02 mm[.355 in]
PCB Thickness (Recommended)	1.4 – 2.4 mm[.055 – .094 in]
Connector Height	3.56 mm[.14 in]

Usage Conditions



Housing Temperature Rating	Standard
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Operating Temperature Range	-65 – 125 °C[-85 – 257 °F]
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Operation/Application

Solder Process Feature	Board Standoff
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Circuit Application	Signal
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Industry Standards

Compatible With Approved Standards Products	CSA LR7189, UL E28476
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UL Flammability Rating	UL 94V-0
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Packaging Features

Packaging Quantity	15
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Packaging Method	Box, Tube
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Product Compliance

[For compliance documentation, visit the product page on TE.com>](#)

EU RoHS Directive 2011/65/EU	Not Compliant
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EU ELV Directive 2000/53/EC	Compliant with Exemptions
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China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold
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EU REACH Regulation (EC) No. 1907/2006	<p>Current ECHA Candidate List: JAN 2025 (247)</p> <p>Candidate List Declared Against: JAN 2025 (247)</p> <p>SVHC > Threshold: Pb (13% in 4690948374)</p> <p>Article Safe Usage Statements: Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.</p>
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Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
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Solder Process Capability	Wave solder capable to 240°C
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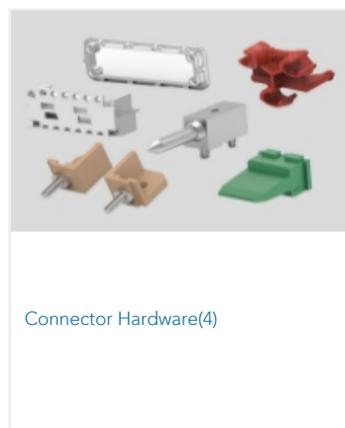
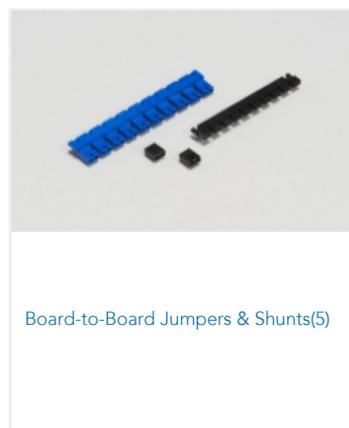
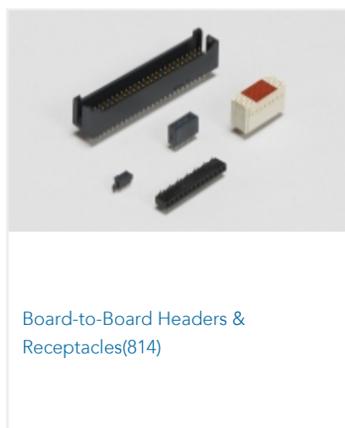
Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

Compatible Parts



Also in the Series | Modu Connector System



Customers Also Bought



Documents

[Product Drawings](#)

15 MODIV VRT SR CE 100/115

English



CAD Files

3D PDF

English

Customer View Model

[ENG_CVM_1-535541-3_N.3d_igs.zip](#)

English

Customer View Model

[ENG_CVM_1-535541-3_N.3d_stp.zip](#)

English

Customer View Model

[ENG_CVM_1-535541-3_N.2d_dxf.zip](#)

English

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Product Specifications

Application Specification

English